





#### COMPLEMENTARY 15V NPN & 12V PNP LOW SATURATION TRANSISTORS IN SOT26

### **Features and Benefits**

- Pd = 1.1W in SOT26 Package
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability
- PPAP Capable (Note 4)

#### **NPN Transistor**

- BVcFo > 15V
- I<sub>C</sub> = 1.5A Continuous Collector Current
- Low Saturation Voltage (100mV max @ 1A)
- R<sub>SAT</sub> = 135mΩ @1.5A for a Low Equivalent On-Resistance

#### **PNP Transistor**

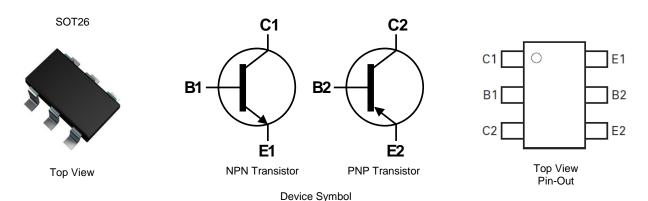
- BV<sub>CEO</sub> > -12V
- I<sub>C</sub> = -1.25A Continuous Collector Current
- Low Saturation Voltage (-140mV max @ -1A)
- $R_{SAT} = 150 m\Omega$  @ 1.2A for a Low Equivalent On-Resistance

### **Mechanical Data**

- Case: SOT26
- Case Material: Molded Plastic, "Green" Molding Compound;
   UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Plated Leads; Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.015 grams (Approximate)

### **Applications**

- Efficient Driving Functions including Motors, Lamps, Relays and Solenoids
- High Output Current Switches



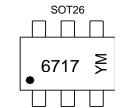
### Ordering Information (Notes 4 & 5)

Product	Compliance	Marking	Reel size (inches)	Tape width (mm)	Quantity per reel
ZXTD6717E6TA	AEC-Q101	6717	7	8	3,000
ZXTD6717E6QTA	Automotive	6717	7	8	3,000

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- See http://www.diodes.com/quality/lead\_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. Automotive products are AEC-Q101 qualified and are PPAP capable. Automotive, AEC-Q101 and standard products are electrically and thermally the same, except where specified. For more information, please refer to http://www.diodes.com/quality/product\_compliance\_definitions/.
- 5. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

### **Marking Information**



6717 = Product Type Marking Code YM = Date Code Marking

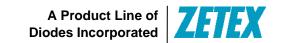
Y or  $\overline{Y}$  = Year (ex: C = 2015)

M or  $\overline{M}$  = Month (ex: 9 = September)

#### Date Code Key

Year	201	5	2016	2017	2018	2019	2020	202	1 20	22 2	2023	2024	2025
Code	С		D	E	F	G	Н	1	,	J	K	L	М
Montl	h	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	)	1	2	3	4	5	6	7	8	9	0	N	D





## NPN - Absolute Maximum Ratings (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Collector-Base Voltage	$V_{CBO}$	15	V
Collector-Emitter Voltage	V <sub>CEO</sub>	15	V
Emitter-Base Voltage	V <sub>EBO</sub>	7	V
Peak Pulse Current	I <sub>CM</sub>	5	Α
Continuous Collector Current	Ic	1.5	Α
Base Current	I <sub>B</sub>	200	mA

## PNP - Absolute Maximum Ratings (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Collector-Base Voltage	V <sub>CBO</sub>	-12	V
Collector-Emitter Voltage	V <sub>CEO</sub>	-12	V
Emitter-Base Voltage	V <sub>EBO</sub>	-7	V
Peak Pulse Current	I <sub>CM</sub>	-3	Α
Continuous Collector Current	Ic	-1.25	Α
Base Current	I <sub>B</sub>	-200	mA

# Thermal Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit	
Power Dissipation	(Note 6)		1.1 8.8	W	
Linear Derating Factor	(Note 7)	P <sub>D</sub>	1.7 13.6	mW/°C	
Thermal Resistance, Junction to Ambient	(Note 6)	Р.,	125		
Thermal Resistance, Junction to Ambient	(Note 7)	$R_{ hetaJA}$	45	°C/W	
Thermal Resistance, Junction to Lead	$R_{ heta JL}$	95			
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-55 to +150	°C		

### ESD Ratings (Note 9)

Characteristic	Symbol	Value	Unit	JEDEC Class
Electrostatic Discharge - Human Body Model	ESD HBM	4,000	V	3A
Electrostatic Discharge - Machine Model	ESD MM	400	V	С

<sup>6.</sup> For a device mounted with the collector lead on 25mm x 25mm 1oz copper that is on a single-sided 1.6mm FR4 PCB; the device is measured under still air conditions whilst operating in a steady-state. Two active dice running at equal power with heatsink split 50% to each collector.

<sup>7.</sup> Same as Note 6, except the device is measured at t < 5 seconds.

<sup>8.</sup> Thermal resistance from junction to solder-point (at the end of the collector lead).

9. Refer to JEDEC specification JESD22-A114 and JESD22-A115.





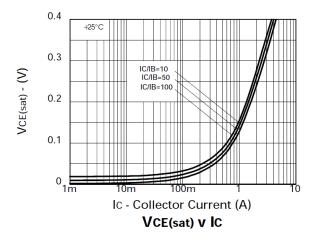
# NPN - Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

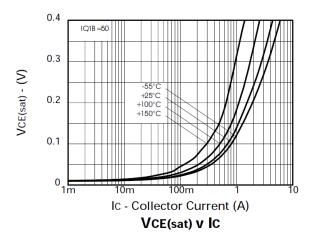
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS						
Collector-Base Breakdown Voltage	BV <sub>CBO</sub>	15	_	_	V	$I_C = 100\mu A, I_E = 0$
Collector-Emitter Breakdown Voltage (Note 10)	BV <sub>CEO</sub>	15	_	_	V	$I_C = 10 \text{mA}, I_B = 0$
Emitter-Base Breakdown Voltage	BV <sub>EBO</sub>	7	_	_	V	$I_E = 100\mu A, I_C = 0$
Collector Cut-Off Current	I <sub>CBO</sub>	1	<-1	10	nA	V <sub>CB</sub> = 10V
Emitter Cut-Off Current	I <sub>EBO</sub>	1	<-1	10	nA	V <sub>EB</sub> =5.6
Emitter Cut-Off Current	I <sub>CES</sub>	_	<-1	10	nA	V <sub>CE</sub> = 10V
ON CHARACTERISTICS (Note 10)						
DC Current Gain	h <sub>FE</sub>	200 300 250 200 75 30	420 450 390 300 150 75	_ _ _ _	_	$\begin{split} I_C &= 10 \text{mA}, \ V_{CE} = 2 \text{V} \\ I_C &= 100 \text{mA}, \ V_{CE} = 2 \text{V} \\ I_C &= 500 \text{mA}, \ V_{CE} = 2 \text{V} \\ I_C &= 14, \ V_{CE} = 2 \text{V} \\ I_C &= 34, \ V_{CE} = 2 \text{V} \\ I_C &= 54, \ V_{CE} = 2 \text{V} \end{split}$
Collector-Emitter Saturation Voltage	V <sub>CE(sat)</sub>		16.5 40 75 150 205	20 55 100 200 245	mV mV mV mV	$I_C = 100$ mA, $I_B = 10$ mA $I_C = 250$ mA, $I_B = 10$ mA $I_C = 500$ mA, $I_B = 10$ mA $I_C = 1$ A, $I_B = 10$ mA $I_C = 1.5$ A, $I_B = 20$ mA
Base-Emitter Saturation Voltage	V <sub>BE(sat)</sub>	1	0.93	1.10	V	$I_C = 1.5A$ , $I_B = 20mA$
Base-Emitter Turn-On Voltage	V <sub>BE(on)</sub>	1	0.865	1.10	V	$I_C = 1.5A, V_{CE} = 2V$
SMALL SIGNAL CHARACTERISTICS						
Output Capacitance	C <sub>obo</sub>	_	15		pF	$V_{CB} = 10V$ , $f = 1.0MHz$
Current Gain Bandwidth Product	f <sub>T</sub>	_	180	_	MHz	$I_C = 50 \text{mA}, V_{CE} = 10 \text{V}$ f = 100MHz
SWITCHING CHARACTERISTICS	,				1	
Turn-On Time	t <sub>on</sub>	_	50		ns	$I_C = 1A$ , $V_{CC} = 10V$
Turn-Off Time	t <sub>off</sub>	_	250		ns	$I_{B1} = -I_{B2} = 100 \text{mA}$

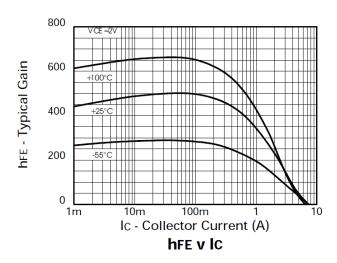
Note: 10. Measured under pulsed conditions. Pulse width  $\leq 300 \mu s$ . Duty cycle  $\leq 2\%$ .

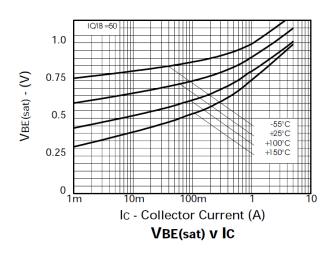


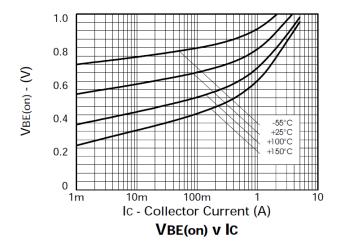
## NPN - Typical Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

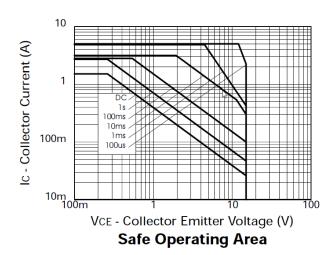
















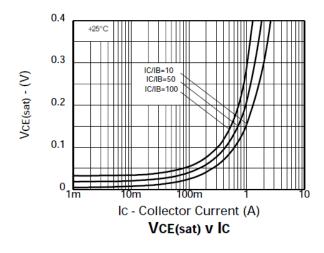
# PNP - Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

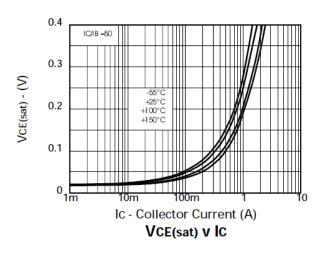
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS						
Collector-Base Breakdown Voltage	BV <sub>CBO</sub>	-12	_		V	$I_C = -100\mu A, I_E = 0$
Collector-Emitter Breakdown Voltage (Note 11)	BV <sub>CEO</sub>	-12	_	_	V	$I_C = -10 \text{mA}, I_B = 0$
Emitter-Base Breakdown Voltage	BV <sub>EBO</sub>	-7	_	_	V	$I_E = -100\mu A, I_C = 0$
Collector Cut-Off Current	I <sub>CBO</sub>	_	<-1	-10	nA	V <sub>CB</sub> = -10V
Emitter Cut-Off Current	I <sub>EBO</sub>	_	<-1	-10	nA	V <sub>EB</sub> = -5.6V
Emitter Cut-Off Current	I <sub>CES</sub>	_	<-1	-10	nA	V <sub>CE</sub> = -10V
ON CHARACTERISTICS (Note 11)						
DC Current Gain	h <sub>FE</sub>	300 300 200 125 75 30	490 450 340 250 140 80		_	$\begin{split} I_C &= -10 \text{mA}, \ V_{CE} = -2 \text{V} \\ I_C &= -100 \text{mA}, \ V_{CE} = -2 \text{V} \\ I_C &= -500 \text{mA}, \ V_{CE} = -2 \text{V} \\ I_C &= -1.25 \text{A}, \ V_{CE} = -2 \text{V} \\ I_C &= -2 \text{A}, \ V_{CE} = -2 \text{V} \\ I_C &= -3 \text{A}, \ V_{CE} = -2 \text{V} \end{split}$
Collector-Emitter Saturation Voltage	VCE(sat)	_	-25 -55 -110 -160 -185	-40 -100 -175 -215 -240	mV mV mV mV	$I_C = -100$ mA, $I_B = -10$ mA $I_C = -250$ mA, $I_B = -10$ mA $I_C = -500$ mA, $I_B = -10$ mA $I_C = -1$ A, $I_B = -50$ mA $I_C = -1.25$ A, $I_B = -100$ mA
Base-Emitter Saturation Voltage	V <sub>BE(sat)</sub>	_	-0.99	-1.10	V	I <sub>C</sub> = -1.25A, I <sub>B</sub> = -100mA
Base-Emitter Turn-On Voltage	V <sub>BE(on)</sub>	_	-0.85	-1.0	V	I <sub>C</sub> = -1.25A, V <sub>CE</sub> = -2V
SMALL SIGNAL CHARACTERISTICS						
Output Capacitance	$C_obo$		15		pF	$V_{CB} = -10V, f = 1.0MHz$
Current Gain Bandwidth Product	f⊤	_	220		MHz	$I_{C} = -50 \text{mA}, V_{CE} = -10 \text{V}$ f = 100MHz
SWITCHING CHARACTERISTICS			1		ı	
Turn-On Time	t <sub>on</sub>	_	50		ns	$I_C = -1A$ , $V_{CC} = -10V$
Turn-Off Time	t <sub>off</sub>	_	135	_	ns	$I_{B1} = -I_{B2} = -100 \text{mA}$

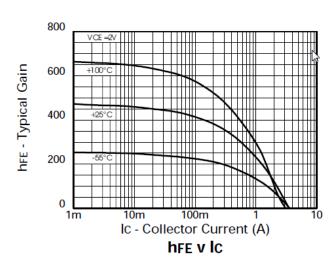
Note: 11. Measured under pulsed conditions. Pulse width  $\leq$  300 $\mu$ s. Duty cycle  $\leq$  2%.

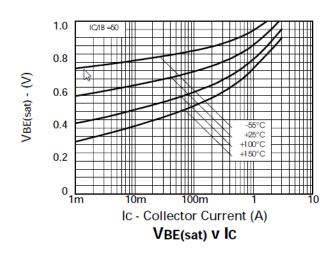


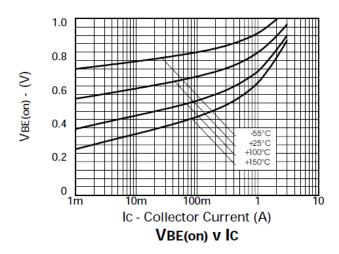
## PNP - Typical Electrical Characteristics (@TA = +25°C, unless otherwise specified.)

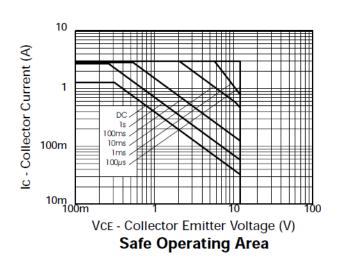








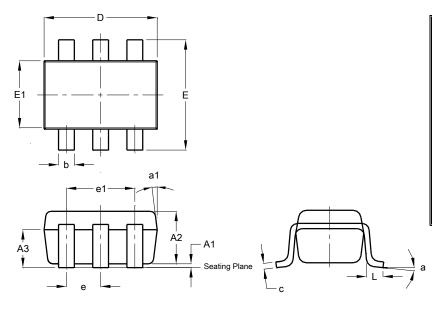






## **Package Outline Dimensions**

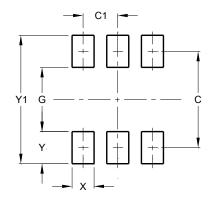
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.



	SOT26						
Dim	Min	Max	Тур				
A1	0.013	0.10	0.05				
A2	1.00	1.30	1.10				
A3	0.70	0.80	0.75				
b	0.35	0.50	0.38				
C	0.10	0.20	0.15				
D	2.90	3.10	3.00				
е	-	-	0.95				
e1	-	-	1.90				
Е	2.70	3.00	2.80				
E1	1.50	1.70	1.60				
L	0.35	0.55	0.40				
а	-	-	8°				
a1	-	-	7°				
All	Dimen	sions i	in mm				

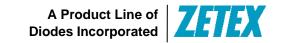
# **Suggested Pad Layout**

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)
C	2.40
C1	0.95
G	1.60
Х	0.55
Y	0.80
Y1	3.20





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